Specification of Thermoelectric Module

TES1-12760

Description

The 127 couples, 30 mm x 30mm size module is a single stage module which is made of our high performance ingot to achieve superior cooling performance and 70° C or larger delta Tmax, is designed for superior cooling and heating applications. Beyond the standard below, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

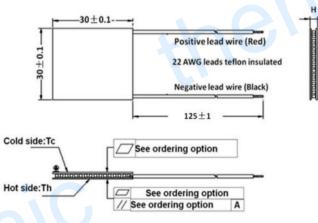
Performance Specification Sheet

Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

Th (°C)	27	50	Hot side temperature at environment: dry air, N ₂
DT _{max} (°C)	70	79	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side
U _{max} (Voltage)	15.9	17.2	Voltage applied to the module at DT _{max}
I _{max} (Amps)	6	6	DC current through the modules at DT _{max}
Q _{Cmax} (Watts)	60.5	65.1	Cooling capacity at cold side of the module under DT=0 °C
AC resistance (Ohms)	2.0	2.2	The module resistance is tested under AC
Tolerance (%)	± 10		For thermal and electricity parameters

Geometric Characteristics Dimensions in millimeters



Manufacturing Options

- A. Solder:B. Sealant:1. T100: BiSn (Tmelt=138°C)1. NS: No sealing (Standard)2. T200: CuAgSn (Tmelt = 217°C)2. SS: Silicone sealant3. T240: SbSn (Tmelt = 240°C)3. EPS: Epoxy sealantC. Ceramics:D. Ceramics Surface Options:1. Alumina (Al₂O₃, white 96%)1. Blank ceramics (not metalized)
- 2. Aluminum Nitride (AlN)
- 2. Metalized

Naming for the Module

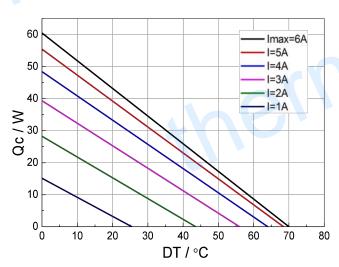
Ordering Option

TES1-12760- X-X-X-X Thickness Flatness/ Lead wire length(mm) Suffix Standard/Optional length H (mm) Parallelism (mm) Ceramics Flatness/ Parallelism TF $0:2.9\pm0.1$ 0: 0.07/0.07 125±1/Specify Sealant Solder TF $1: 2.9 \pm 0.03$ 1:0.025/0.025 125±1/Specify TES1-12760-T100-SS -TF01 -AlO T100: BiSn(Tmelt=138°C) Eg. TF01: Thickness 2.9 ± 0.1 (mm) and Flatness 0.025/0.025 (mm) SS: Silicone sealant AlO: Alumina, white 96%

Creative technology with fine manufacturing processes provides you the reliable and quality products Tel: +86-791-88198288 Fax: +86-791-88198308 Email: <u>sales@thermonamic.com.cn</u> Web Site: www.thermonamic.com.cn

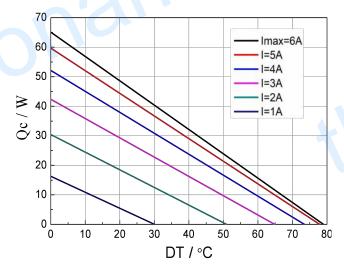
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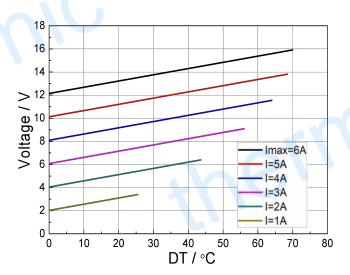


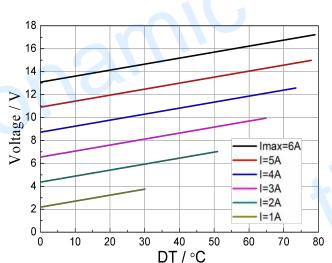
Performance Curves at Th=27 °C

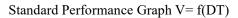
Performance Curves at Th=50 °C

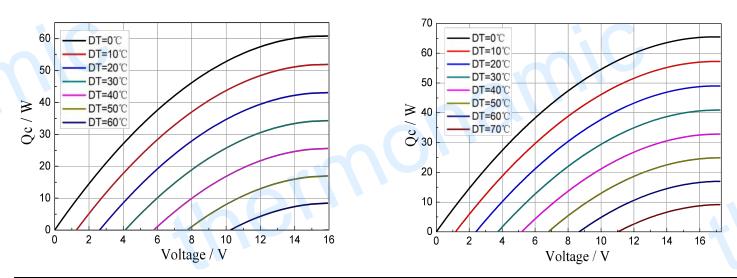


Standard Performance Graph Qc = f(DT)









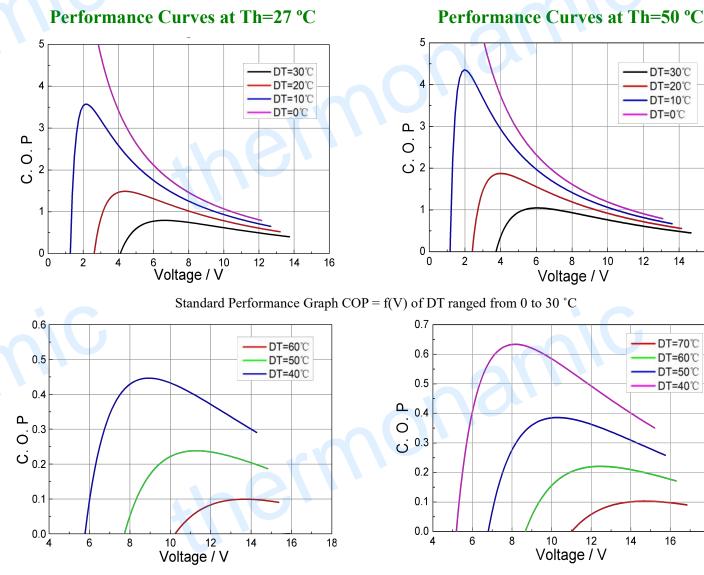
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Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power ($V \times I$).

Operation Caution

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Operation below I_{max} or V_{max}
- Work under DC

Note: All specifications subject to change without notice.